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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KAZUHITO WATANABE	10/20/2017
JUJI YOKOYA	10/19/2017
NORIO YAGISHITA	10/19/2017
YUKA TSUSHIMA	10/17/2017
MICHIO YOKOYAMA	10/20/2017
HIDEAKI YONOGA	12/22/2014
YASUHIDE MATSUMOTO	12/22/2014
ROKURO IWASE	12/22/2014

RECEIVING PARTY DATA

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Name:	M.SOFT CO., LTD.
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	· ·
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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14411664	

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PATENT

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ATTORNEY DOCKET NUMBER: 5066-0001

NAME OF SUBMITTER: ERIC D. MOREHOUSE

SIGNATURE: /Eric D. Morehouse/

DATE SIGNED: 10/20/2017

Total Attachments: 10
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ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

SUPPORT DEVICE AND SYSTEM FOR ARTICLE PICKING WORK

for which WE filed PCT Application No. PCT/JP2013/065205 on May 31, 2013 and for which WE executed an application for United States Letters Patent concurrently herewith; and

WHEREAS TOYO KANETSU SOLUTIONS K.K., a corporation of Japan, whose post office address is 19-20, Higashisuna 8-chome, Koto-ku, Tokyo 136-8666 Japan and M.SOFT CO., LTD., a corporation of Japan, whose post office address is 18-10, Higashiueno 2-chome, Taito-ku, Tokyo 110-0015, Japan (hereinafter collectively referred to as Assignee), are desirous of jointly and equally securing and sharing the entire right, title, and interest in and to this invention in all countries throughout the world in equal and joint portion, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof, and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authorize and request the attorneys WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. ________, filed ________) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Full Name of First Assignor Kazubito WATANABE	Assignor's Signature Razuhih	Untonabe	Date October 20. 2017
Address: c/o TOYO KANETSU SOLUTIONS K.K. 19-20, Higashisuna 8-chome, Koto-ku, Tok			<u>Citizenship</u> Japan
Names of additional invent		[X] Yes	[] No

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	ATTORNEY DOCK	ET NO.: 5066-0001
U.S.	Patent Application No.:	Page 2 of 10

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The facility of the facility o		
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Full Name of Third Assignar Juji YOKOYA	Assignor's Signature Juje Yofu	y a	Date October 19 2017
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Names of additional i	inventors attached	[x] Yes	[]No

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Full Name of Fourth Assignor Norio YAGISHITA	Assignor's Signature Norio Yograhita	Date October 192017
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Names of additional inver	ntors attached [x] Yes	[] No

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ATTORNEY DOCKET NO.: 5066-000	1
U.S. Patent Application No.:	

Page 6 of 10

Full Name of Sixth Assignor Yuka TSUSHIMA	Assignor's Signature Yuzu Tsushima		Date October 17. 2017
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Names of additional inv	entors attached [3	τ] Yes	{ } No

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ATTORNEY DOCKET NO.: 5066-0001

U.S. Patent Application No.:

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Full Name of Seventh Assignor Michio YOKOYAMA Address: c/o TOYO KANETSU SOLUTIONS K.K 19-20, Higashisuna 8-chome, Koto-ku, To	Assignor's Signature Brichio Yrhogana kyo, 136-8666 Japan	Date October 20. 2017 Citizenship Japan
Names of gidditional java	entors attached [X] Yes	[]No

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ATTORNEY DOCKET NO.: 5066-0001

U.S. Patent Application No.:

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Full Name of Ninth Assignor Yasuhide MATSUMOTO	Assignor's Signature 私本泰	趸	<u>Date</u> December,	22-2014.
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Names of additional inve	ntors attached	[x] Yes	[]No	

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Page 10 of 10

Full Name of Tenth Ass Rokuro IWASE	ignor	Assignor's Signature	lwase !	Date December 22,20/9
Address: c/o M.SOFT Co. 18-10, Higashiue	, Ltd. no 2-chome, Taito-ku, Tol	,		<u>Citizenship</u> Japan
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T.	ames of additional invent	ors attached	[] Yes	{ x } No

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